# SGC9395-300A-R

## X-band Internally Matched GaN-HEMT

#### ■ Features

• High Output Power: P<sub>sat</sub>=55.3dBm (Typ.)

• High Gain:  $G_p = 9.3 dB$  (Typ.)

High Power Added Efficiency: PAE=35% (Typ.)

• Frequency Band: 9.3 to 9.5GHz

• Impedance Matched Zin/Zout = 50ohm

· Hermetically Sealed Package

### ■ Description

The SGC9395-300A-R is a high power GaN-HEMT that is internally matched for X-band radar bands to provide optimum power and gain in a 500hm system.



ABSOLUTE MAXIMUM RATING (Case Temperature  $T_c=25 \text{ deg.C}$ )

Item	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	55	V
Gate-Source Voltage	$V_{GS}$	-15	V
Storage Temperature	T <sub>sta</sub>	-55 to +125	deg.C
Channel Temperature	T <sub>ch</sub>	+250	deg.C

RECOMMENDED OPERATING CONDITION

RECOMMENDED OF EXAMING CONDITION					
Item	Symbol	Condition	Limit	Unit	
Drain-Source Voltage	$V_{DS}$		<=50	V	
Forward Gate Current	$I_{GF}$	Rg=10ohm	<=187.2	mA	
Reverse Gate Current	$I_{GR}$	Rg=10ohm	>=-13.6	mA	
Channel Temperature	Tch		<+200	deg.C	

**ELECTRICAL CHARACTERISTICS (Case Temperature T<sub>c</sub>=25 deg.C)** 

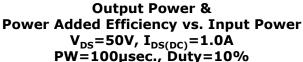
Item	Symbol	Condition		Limit		Unit
	Syllibol		Min.	Тур.	Max.	Unit
Pinch-off Voltage	V <sub>P</sub>	$V_{DS} = 50V$ , $I_{DS} = 20.0$ mA	-	-4.5	-	V
Frequency Range	Freq.	$V_{DS} = 50V$ -typ.	9.3	-	9.5	GHz
Output Power	$P_{sat}$	$I_{DS(DC)}=1.0A$ -typ.	54.3	55.3	-	dBm
Power Gain	$G_P$	Pulse Width=100µsec.	8.3	9.3	-	dB
Drain Current	$I_{DSR}$	Duty=10%	-	17.1	19.5	Α
Power Added Efficiency	PAE	Pin=46dBm	-	35	-	%
Thermal Resistance	R <sub>th</sub>	Channel to Case (Pdiss=100W, CW)	-	0.7	0.8	deg.C/W

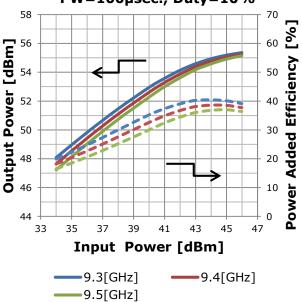
CASE STYLE	IK	
RoHS Compliance	YES	
ESD	Class 2	2000V to <4000V

Note: Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)

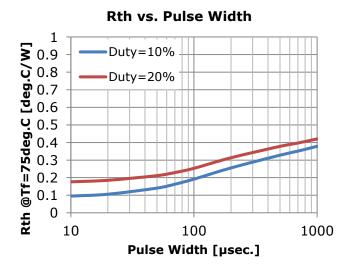


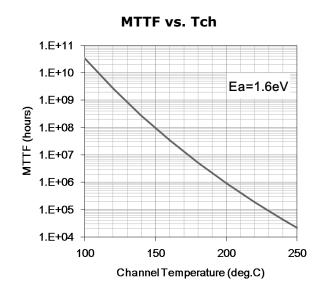
#### RF Characteristics





## • Thermal Characteristics In Pulsed Operation

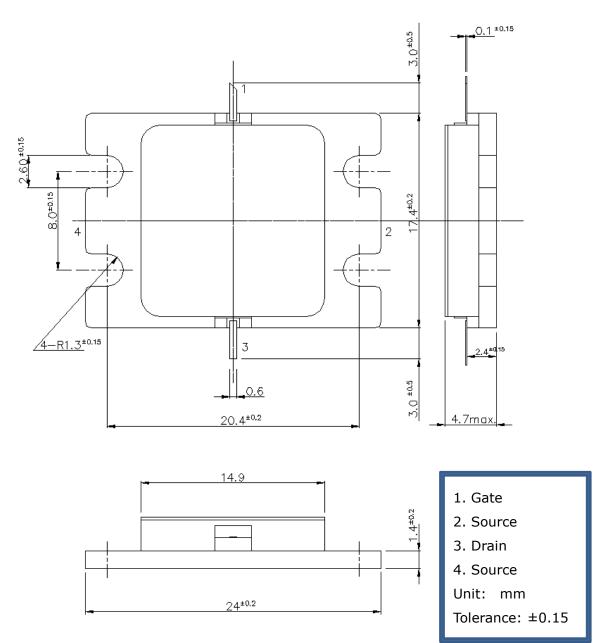






### • Package Outline

Case Style : IK





#### For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.
   This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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